

APPLICATION FOR CONCURRENT DOUBLE MASTER DEGREE PROGRAM IN LOGISTICS & SUPPLY CHAIN MANAGEMENT

Name: _____ <i>(Please underline surname/family name)</i>	Gender: <input type="checkbox"/> Female <input type="checkbox"/> Male	Date of Birth: <i>(DD/MM/YYYY)</i> _____
Home/Mailing Address: _____	Race: _____	Country of Birth: _____
Matriculation No.: _____ Faculty/School: <input type="checkbox"/> Business <input type="checkbox"/> Computing <input type="checkbox"/> Engineering <input type="checkbox"/> Science <input type="checkbox"/> Others: _____	E-mail: Mobile No.: Residence No.:	
Degree and Special Programs currently reading: (e.g. Double Degrees, USP, NOC) Year of Study (at time of application) : _____		

Mathematical Modules Completed (If alternative modules are taken, enter equivalent module code and title)

Code	Description	Or Equivalent Module & Code	Grade	CAP at end of (Yr 1 – 4)	
MA1101R <i>or</i> MA1506	Linear Algebra <i>or</i> Mathematics II			Yr1	
MA1507 <i>or</i> MA1505 <i>or</i> MA1102R	Advanced Calculus <i>or</i> Mathematics I <i>or</i> Calculus			Yr 2	
MA2216	Probability (<i>or</i> precluded modules in MA2216)			Yr 3	
MA3238	Stochastic Process (<i>or</i> precluded modules in MA3238)			Yr 4	
MA3252	Network Optimization (<i>or</i> precluded modules in MA3252)				

GRE Score Verbal: _____ **Quantitative:** _____ **Analytical:** _____ **Date of test:** _____

If you have not taken the GRE, when do you intend to take the test? _____

When do you intend to have 6-month Internship? *(typically this would be from Jul to Dec in 5th year of study)*

Please state, if you are receiving an undergraduate Scholarship

Name of Scholarship: _____ **Scholarship awarding Body:** _____

Duration of Bond (if any): _____ **Bond commencement date:** _____

What are the bond conditions?

I wish to apply for a scholarship under The Logistics Institute – Asia Pacific Scholarship Scheme. For details of the scholarship, please refer to the website: http://www.tliap.nus.edu.sg/dmp/app/fees.aspx#program_sas
 (Scholarship holders are required to work in Singapore for 3 years after graduation)

I hereby certify that the above information is correct.

 Signature

 Date

**Please submit this form together with your transcripts/results slip together with CDMP Annex 1 – 2.3 to:
 DMP Administrator: 21 Heng Mui Keng Terrace #04-01 | Tel: 6516-4284 | E: tliidmp@nus.edu.sg**

Notes: * All applicants will be acknowledged via email. * Those who are shortlisted for scholarship awards will be informed via email to attend the scholarship interview. * Applicants may refer to <http://www.tliap.nus.edu.sg/dmp/app/process.aspx> on the general schedule of admission.